62 mm C-Series module



Final datasheet

62 mm C-Series module with CoolSiC™ Trench MOSFET

Features

- Electrical features
 - V_{DSS} = 2000 V
 - $I_{DN} = 300 \text{ A} / I_{DRM} = 600 \text{ A}$
 - Low switching losses
 - High current density
 - Suitable Infineon gate drivers can be found under https://www.infineon.com/gdfinder
- Mechanical features
 - 4 kV AC 1 min insulation

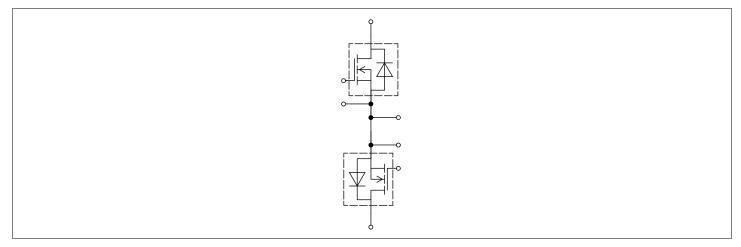
Potential applications

- UPS systems
- DC/DC converter
- High-frequency switching application
- Solar applications

Product validation

• Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description





62 mm C-Series module



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62 mm C-Series module

1 Package



1 Package

Table 1 Insulation coordination

| Parameter | Symbol | Note or test condition | Values | Unit |
|-------------------------------------|------------------------|---------------------------------------|--------------------------------|------|
| Isolation test voltage | V _{ISOL} | RMS, f = 50 Hz, t = 1 min | 4.0 | kV |
| Material of module baseplate | | | Cu | |
| Internal isolation | | basic insulation (class 1, IEC 61140) | Al ₂ O ₃ | |
| Creepage distance | d _{Creep nom} | terminal to baseplate, nom. | 29.0 | mm |
| Creepage distance | $d_{\text{Creep nom}}$ | terminal to terminal, nom. | 23.0 | mm |
| Clearance | $d_{Clearnom}$ | terminal to baseplate, nom. | 23.0 | mm |
| Clearance | $d_{\text{Clear nom}}$ | terminal to terminal, nom. | 11.0 | mm |
| Comparative tracking index | СТІ | | > 400 | |
| Relative thermal index (electrical) | RTI | | 140 | °C |

Table 2 Characteristic values

| Parameter | Symbol | Note or test condition | | | Values | | |
|---|----------------------|--|-----------|------|--------|------|----|
| | | | | Min. | Тур. | Мах. | |
| Stray inductance module | L _{sCE} | | | | 20 | | nH |
| Module lead resistance, terminals - chip | R _{CC'+EE'} | T_C = 25 °C, per switch | | | 0.4 | | mΩ |
| Storage temperature | $T_{\rm stg}$ | | | -40 | | 125 | °C |
| Mounting torque for module mounting | М | - Mounting according to valid application note | M6, Screw | 3 | | 6 | Nm |
| Terminal connection torque | М | - Mounting according to valid application note | M6, Screw | 2.5 | | 5 | Nm |
| Weight | G | | • | | 340 | | g |

Note:

The electrical characterization was performed in NPC2 topology, which combines the modules FF4MR20KM1H and FF4MR20KM1H_S.

It has to be considered, that the commutation in this configuration takes place between both modules.

2 MOSFET, T1 / T2

Table 3 Maximum rated values

| Parameter | Symbol | Note or test condition | | Values | Unit |
|---------------------------|-----------------|------------------------|-------------------------|--------|------|
| Drain-source voltage | V_{DSS} | | T _{vj} = 25 °C | 2000 | V |
| Implemented drain current | I _{DN} | | | 300 | Α |

(table continues...)

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2 MOSFET, T1 / T2

Table 3 (continued) Maximum rated values

| Parameter | Symbol | Note or test condition | | Values | Unit |
|---|------------------|--|------------------------|--------|------|
| Continuous DC drain current | I _{DDC} | $T_{\rm vj}$ = 175 °C, $V_{\rm GS}$ = 18 V | T _C = 25 °C | 280 | А |
| Repetitive peak drain current | / _{DRM} | verified by design, t _p limited by T _{vjmax} | | 600 | А |
| Gate-source voltage, max. transient voltage | V _{GS} | D < 0.01 | | -10/23 | V |
| Gate-source voltage, max. static voltage | V _{GS} | | | -7/20 | V |

Table 4 Recommended values

| Parameter | Symbol | Note or test condition | Values | Unit |
|------------------------|----------------------|------------------------|--------|------|
| On-state gate voltage | V _{GS(on)} | | 18 | V |
| Off-state gate voltage | V _{GS(off)} | | -3 | V |

Table 5 Characteristic values

| Parameter | Symbol | Note or test condition | | Values | | | Unit |
|--------------------------------|---------------------|--|--|--------|-------|------|------|
| | | | | Min. | Тур. | Max. | |
| Drain-source on-resistance | R _{DS(on)} | I _D = 300 A | $V_{\rm GS} = 18 \text{ V},$ $T_{\rm vj} = 25 ^{\circ}\text{C}$ | | 3.5 | 5.3 | mΩ |
| | | | V _{GS} = 18 V, T _{vj} = 125 °C | | 7.3 | | |
| | | | V _{GS} = 18 V, T _{vj} = 175 °C | | 10.4 | | |
| Gate threshold voltage | V _{GS(th)} | I_D = 168 mA, V_{DS} = V_{GS} , T_{vj} = 25 °C, (tested after 1ms pulse at V_{GS} = +20 V) | | 3.45 | 4.3 | 5.15 | V |
| Total gate charge | Q _G | $V_{\rm DD}$ = 1200 V, $V_{\rm GS}$ = -3/18 V, $T_{\rm vj}$ = 25 °C | | | 1.17 | | μC |
| Internal gate resistor | R _{Gint} | T _{vj} = 25 °C | | | 1.2 | | Ω |
| Input capacitance | C _{ISS} | $f = 100 \text{ kHz}, V_{DS} = 1200 \text{ V},$ $V_{GS} = 0 \text{ V}$ | T _{vj} = 25 °C | | 36.1 | | nF |
| Output capacitance | Coss | $f = 100 \text{ kHz}, V_{DS} = 1200 \text{ V},$ $V_{GS} = 0 \text{ V}$ | T _{vj} = 25 °C | | 0.845 | | nF |
| Reverse transfer capacitance | C _{rss} | $f = 100 \text{ kHz}, V_{DS} = 1200 \text{ V},$ $V_{GS} = 0 \text{ V}$ | T _{vj} = 25 °C | | 0.061 | | nF |
| C _{OSS} stored energy | Eoss | $V_{\rm DS}$ = 1200 V, $V_{\rm GS}$ = -3/18 V | , T _{vj} = 25 °C | | 1520 | | μJ |
| Drain-source leakage current | I _{DSS} | $V_{\rm DS}$ = 2000 V, $V_{\rm GS}$ = -3 V | T _{vj} = 25 °C | | 0.06 | 527 | μΑ |
| Gate-source leakage current | I _{GSS} | $V_{\rm DS}$ = 0 V, $T_{\rm vj}$ = 25 °C | V _{GS} = 20 V | | | 400 | nA |

(table continues...)

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2 MOSFET, T1 / T2



Table 5 (continued) Characteristic values

| Parameter | Symbol | Note or test condition | | | Values | | Unit |
|--|--|---|--------------------------|------|--------|-------|------|
| | | | | Min. | Тур. | Max. | |
| Turn-on delay time | $t_{\sf don}$ | $I_{\rm D} = 300 \text{A}, R_{\rm Gon} = 6.8 \Omega,$ | T _{vj} = 25 °C | | 175 | | ns |
| (inductive load) | | $V_{DD} = 1200 \text{ V},$ $V_{GS} = -3/18 \text{ V}$ | T _{vj} = 125 °C | | 165 | | |
| | | VGS = -3/10 V | T _{vj} = 175 °C | | 159 | | |
| Rise time (inductive load) | t _r | $I_{\rm D} = 300 \text{A}, R_{\rm Gon} = 6.8 \Omega,$ | T _{vj} = 25 °C | | 171 | | ns |
| | | $V_{DD} = 1200 \text{ V},$ $V_{GS} = -3/18 \text{ V}$ | T _{vj} = 125 °C | | 154 | | |
| | | VGS - 3/10 V | T _{vj} = 175 °C | | 149 | | |
| Turn-off delay time | t _{d off} | $I_{\rm D} = 300 \text{ A}, R_{\rm Goff} = 2.4 \Omega,$ | T _{vj} = 25 °C | | 190 | | ns |
| (inductive load) | | $V_{DD} = 1200 \text{ V},$ $V_{GS} = -3/18 \text{ V}$ | T _{vj} = 125 °C | | 206 | | |
| | | VGS 3/10 V | T _{vj} = 175 °C | | 214 | | |
| Fall time (inductive load) | $V_{DD} = 1200 \text{ V},$ $V_{GS} = -3/18 \text{ V}$ | T _{vj} = 25 °C | | 54.9 | | ns | |
| | | , | T _{vj} = 125 °C | | 56.6 | | |
| | | | T _{vj} = 175 °C | | 58.6 | | |
| Turn-on energy loss per | E _{on} | $I_{\rm D}$ = 300 A, $V_{\rm DD}$ = 1200 V, L_{σ} = 40 nH, $V_{\rm GS}$ = -3/18 V, $R_{\rm Gon}$ = 6.8 Ω, di/dt = 3.36 kA/µs ($T_{\rm vj}$ = 175 °C) | T _{vj} = 25 °C | | 36.4 | | mJ |
| pulse | | | T _{vj} = 125 °C | | 40.2 | | |
| | | | T _{vj} = 175 °C | | 43.4 | | |
| Turn-off energy loss per | E _{off} | $I_{\rm D}$ = 300 A, $V_{\rm DD}$ = 1200 V, | T _{vj} = 25 °C | | 14.1 | | mJ |
| pulse | | L_{σ} = 40 nH, V_{GS} = -3/18 V, R_{Goff} = 2.4 Ω , dv/dt = 16.4 | T _{vj} = 125 °C | | 15 | | |
| | | $kV/\mu s (T_{vj} = 175 °C)$ | T _{vj} = 175 °C | | 15.7 | | |
| Thermal resistance, junction to case | R _{thJC} | per MOSFET | | | | 0.119 | K/W |
| Thermal resistance, case to heat sink | R_{thCH} | per MOSFET, λ_{grease} = 1 W | /(m*K) | | 0.0380 | | K/W |
| Temperature under switching conditions | T _{vj op} | | | -40 | | 175 | °C |

Note:

The selection of positive and negative gate-source voltages impacts losses and the long-term behavior of the MOSFET and body diode. The design guidelines described in Application Notes AN 2018-09 and AN 2021-13 must be considered to ensure sound operation of the device over the planned lifetime.

 $T_{\rm vj,op}$ > 150 °C is allowed for operation at overload conditions for MOSFET and body diode. For detailed specifications, please refer to AN 2021-13.

62 mm C-Series module



3 Body diode (MOSFET, T1 / T2)

3 Body diode (MOSFET, T1 / T2)

Table 6 Maximum rated values

| Parameter | Symbol | Note or test condition | | Values | Unit |
|-------------------------------|-----------------|---|------------------------|--------|------|
| DC body diode forward current | I _{SD} | $T_{\rm vj} = 175 {\rm ^{\circ}C}, V_{\rm GS} = -3 {\rm V}$ | T _C = 25 °C | 235 | A |

Table 7 Characteristic values

| Parameter | Symbol | Note or test condition | | Note or test condition Values | | | | Unit |
|-----------------|----------|---|--------------------------|-------------------------------|------|------|---|------|
| | | | | Min. | Тур. | Max. | | |
| Forward voltage | V_{SD} | $I_{SD} = 300 \text{ A}, V_{GS} = -3 \text{ V}$ | T _{vj} = 25 °C | | 4.6 | 6.15 | ٧ | |
| | | | T _{vj} = 125 °C | | 4.15 | | | |
| | | | T _{vj} = 175 °C | | 4 | | | |

4 Characteristics diagrams

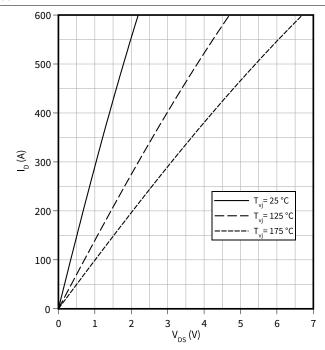


4 Characteristics diagrams

Output characteristic (typical), MOSFET, T1 / T2

 $I_D = f(V_{DS})$

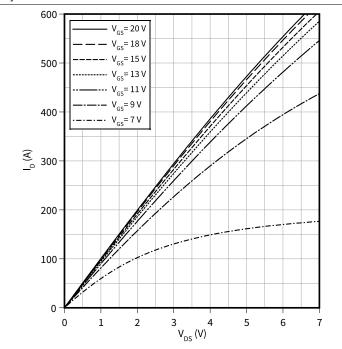
 $V_{GS} = 18 V$



Output characteristic field (typical), MOSFET, T1 / T2

 $I_D = f(V_{DS})$

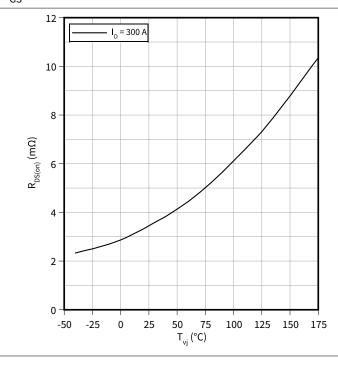
T_{vj} = 175 °C



Drain source on-resistance (typical), MOSFET, T1 / T2

 $R_{DS(on)} = f(T_{vj})$

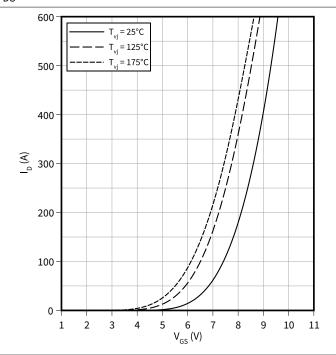
 $V_{GS} = 18 V$



Transfer characteristic (typical), MOSFET, T1 / T2

 $I_D = f(V_{GS})$

 $V_{DS} = 20 V$



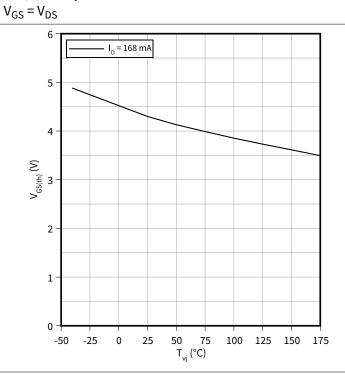
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4 Characteristics diagrams

Gate-source threshold voltage (typical), MOSFET, T1 / T2

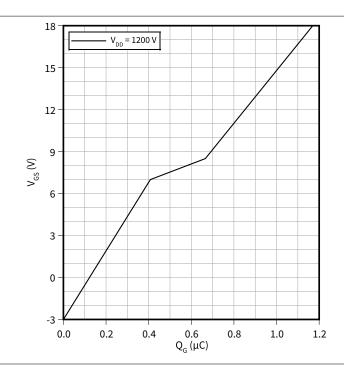
 $V_{GS(th)} = f(T_{vj})$



Gate charge characteristic (typical), MOSFET, T1 / T2

 $V_{GS} = f(Q_G)$

 $I_D = 300 A$, $T_{vj} = 25 °C$



Capacity characteristic (typical), MOSFET, T1 / T2

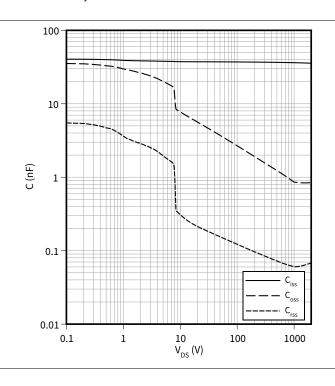
 $C = f(V_{DS})$

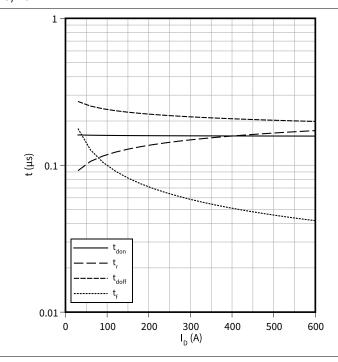
f = 100 kHz, $T_{vj} = 25 \,^{\circ}\text{C}$, $V_{GS} = -3 \,^{\circ}\text{V}$



 $t = f(I_{\Gamma})$

 R_{Goff} = 2.4 Ω , R_{Gon} = 6.8 Ω , V_{DD} = 1200 V, T_{vj} = 175 °C, V_{GS} = -3/18 V





62 mm C-Series module

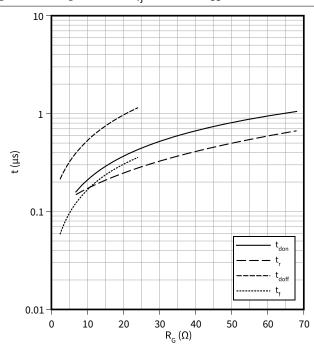


4 Characteristics diagrams

Switching times (typical), MOSFET, T1 $\!\!/$ T2

 $t = f(R_G)$

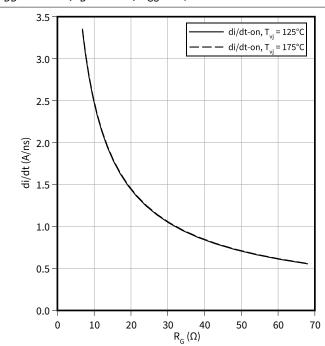
 V_{DD} = 1200 V, I_D = 300 A, T_{vj} = 175 °C, V_{GS} = -3/18 V



Current slope (typical), MOSFET, T1 / T2

 $di/dt = f(R_G)$

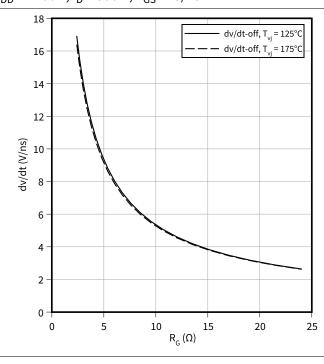
 $V_{DD} = 1200 \text{ V}, I_D = 300 \text{ A}, V_{GS} = -3/18 \text{ V}$



${\bf Voltage\ slope\ (typical),\ MOSFET,\ T1\ /\ T2}$

 $dv/dt = f(R_G)$

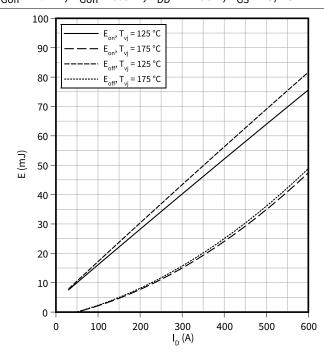
 $V_{DD} = 1200 \text{ V}, I_D = 300 \text{ A}, V_{GS} = -3/18 \text{ V}$



Switching losses (typical), MOSFET, T1 / T2

 $E = f(I_D)$

 R_{Goff} = 2.4 Ω , R_{Gon} = 6.8 Ω , V_{DD} = 1200 V, V_{GS} = -3/18 V



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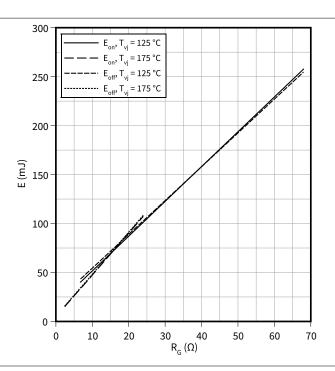


4 Characteristics diagrams

Switching losses (typical), MOSFET, T1 / T2 $\,$

 $E = f(R_G)$

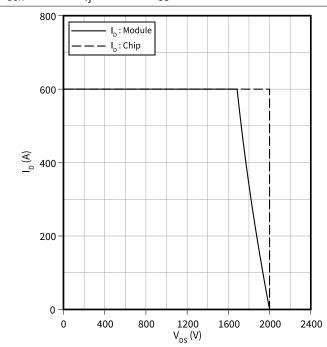
 $V_{DD} = 1200 \text{ V}, I_D = 300 \text{ A}, V_{GS} = -3/18 \text{ V}$



Reverse bias safe operating area (RBSOA), MOSFET, T1/T2

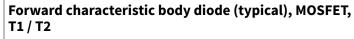
 $I_D = f(V_{DS})$

 $R_{Goff} = 2.4 \Omega, T_{vi} = 175 \, ^{\circ}C, V_{GS} = -3/18 \, V$



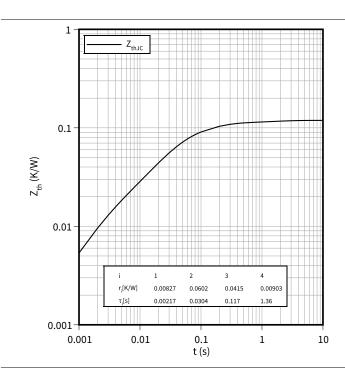
Transient thermal impedance, MOSFET, T1 / T2

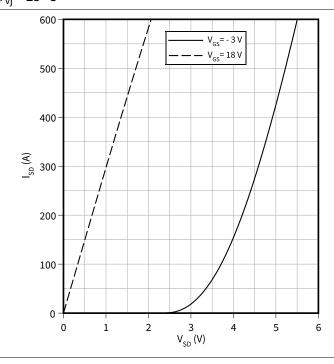
 $Z_{th} = f(t)$



 $I_{SD} = f(V_{SD})$

T_{vi} = 25 °C







5 Circuit diagram

5 Circuit diagram

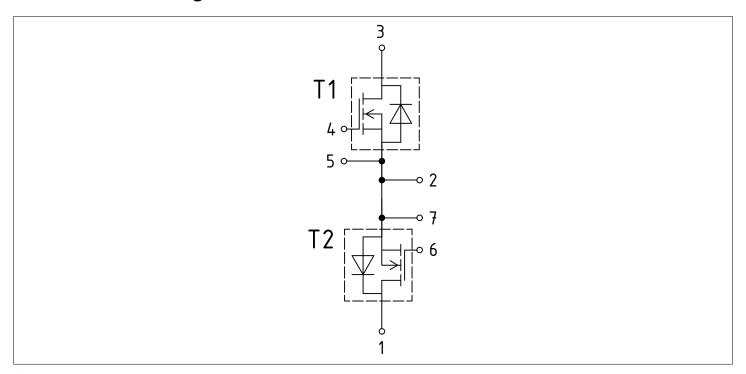


Figure 1

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6 Package outlines

Package outlines 6

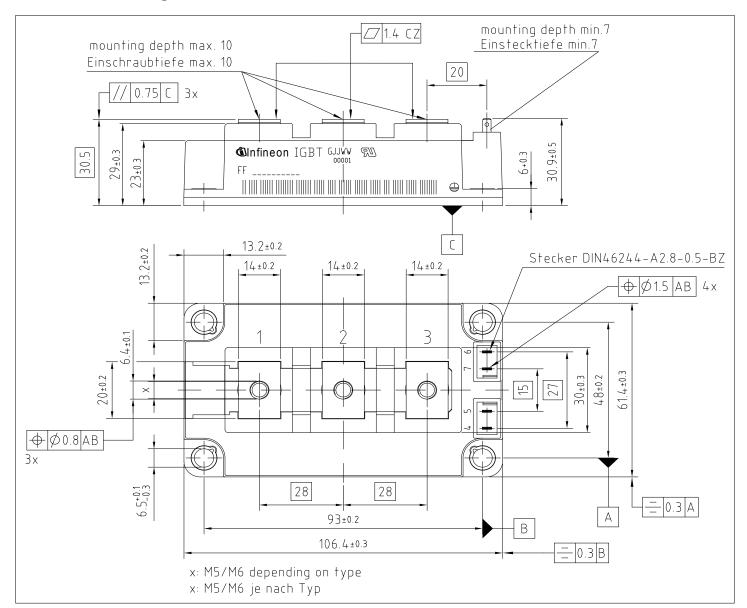
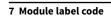


Figure 2

62 mm C-Series module





7 Module label code

| Code format | Data Matrix | | Barcode C | Code128 |
|--------------|--|---|-----------|--|
| Encoding | ASCII text | | Code Set | Ą |
| Symbol size | 16x16 | | 23 digits | |
| Standard | IEC24720 and IEC16022 | | IEC8859-1 | |
| Code content | Content Module serial number Module material number Production order number Date code (production year) Date code (production week) | Module serial number 1 - 5 Module material number 6 - 11 Production order number 12 - 19 Date code (production year) 20 - 21 | | Example 71549 142846 55054991 15 30 |
| Example | 71549142846550549911530 | | | 6550549911530 |

Figure 3

62 mm C-Series module



Revision history

Revision history

| Document revision | Date of release | Description of changes |
|-------------------|-----------------|------------------------|
| 1.00 | 2024-09-05 | Initial version |

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